



Call for Papers



2010 IEEE International Conference on Vehicular Electronics and Safety

Sponsored by the IEEE Intelligent Transportation Systems Society
Qingdao, China, July 15-17, 2010
<http://www.ieeeves.org>

VENUE

ICVES'10 will be held jointly with 2010 IEEE/ASME International Conference on Mechatronic and Embedded Systems and Applications and 2010 IEEE International Conference on Service Operations and Logistics, and Informatics.

The International Conference on Vehicular Electronics and Safety (ICVES'10) is an annual forum sponsored by the IEEE Intelligent Transportation Systems (ITS) Society. It brings together researchers and practitioners to discuss vehicle electronics, and safety systems research and practice. ICVES'10 welcomes papers dealing with any aspect of vehicle electronics and safety systems.

TOPICS OF INTEREST

- Active and Passive Safety Systems
- Telematics
- Vehicular Power Networks
- X-By Wire Technology
- System-on-a-Chip
- Vehicular Sensor
- Vehicle Bus
- Sensor Network
- Embedded Operation System
- Electro Magnetic Compatibility
- Inter-Vehicular Network
- Vehicle Testing
- Vehicle Hardware /Software System
- Navigation and Localization Systems
- Vehicular Measurement Technology
- Vehicular Signal Processing
- Micro-electromechanical Systems
- Image Sensor
- Vehicle/Engine Control
- Driver Assistance Driving Systems
- Adaptive Cruise Control Systems
- Pattern Recognition for Vehicles
- Human Machine Interaction
- Diagnostics on Line
- Virtual/Digital System

CONFERENCE ORGANIZING COMMITTEE

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PAPER SUBMISSION

Complete manuscripts in PDF must be electronically submitted at the conference website: <http://www.ieeeves.org>
Manuscripts should be at most six (6) pages in the IEEE two-column format including figures, tables, and references.
Please refer to the conference website for the most up-to-date information <http://www.ieeeves.org>.
Contact us at: ieeeves2010@gmail.com

IMPORTANT DATES

February 12, 2010

Paper submission deadline

April 18, 2010

Notification of acceptance

May 16, 2010

Camera-ready copy due